

# March 2013 SuperFET II

# FCH041N60F 600V N-Channel MOSFET, FRFET

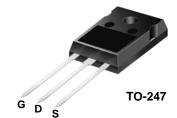
### Features

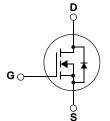
- R<sub>DS(on)</sub>= 36mΩ (Typ)
- Ultra low gate charge (Typ. Q<sub>g</sub>=277nC)
- · Low effective output capacitance
- 100% avalanche tested

SuperFET<sup>®</sup>II is, Farichild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET<sup>®</sup>II is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.

## Description





### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

Symbol		Parameter		FCH041N60F	Units
V <sub>DSS</sub>	Drain to Source Voltage			600	V
V <sub>GSS</sub>	Gate to Source Voltage	-DC	-DC		V
		-AC	(f>1Hz)	±30	V
I <sub>D</sub>	Drain Current	-Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		76	۸
		-Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		48.1	— A
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)		228	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		2025	mJ	
I <sub>AR</sub>	Avalanche Current (No		(Note 1)	15	A
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	5.95	mJ
dv/dt	MOSFET dv/dt	100	V/ns		
	Peak Diode Recovery dv/dt (Note 3)			20	
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)		595	W
		- Derate above 25°C		4.76	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

### **Thermal Characteristics**

Symbol	Symbol Parameter		Units
$R_{\theta JC}$	$R_{\theta JC}$ Thermal Resistance, Junction to Case		°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	40	-0/10

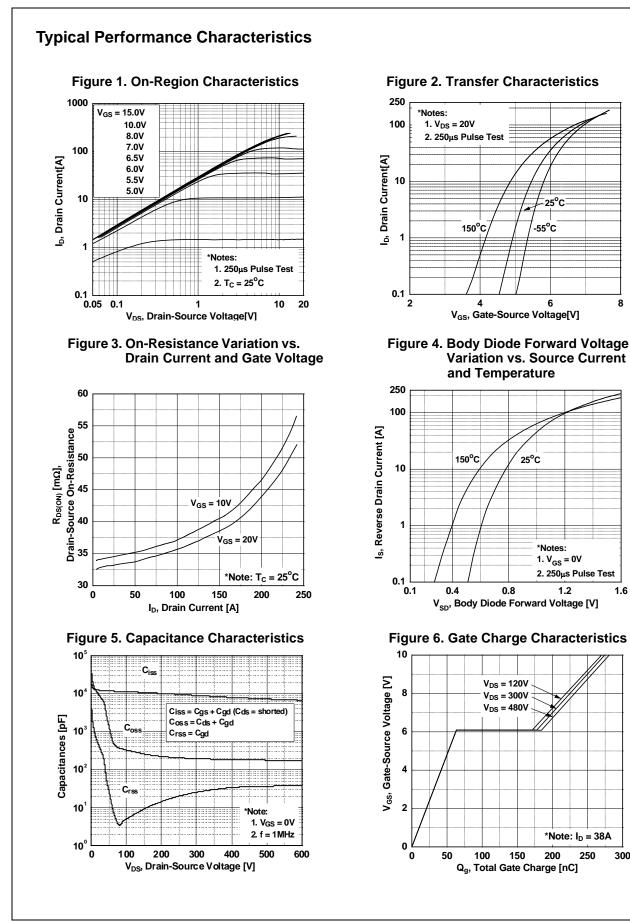
Device Marking Device Pack		Packag	je	Reel Size	Таре	e Width		Quantity	у	
FCH041N60F FCH041N60F TO-24				-	30					
Electrica	l Char	acteristics $T_c$ =	25°C unless	otherwis	se noted	L				
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Units	
Off Charac	teristic	S								
		•		lp = 10	)mA, V <sub>GS</sub> = 0V, T <sub>J</sub> =	= 25°C	600	-	_	V
BV <sub>DSS</sub>	Drain to	Drain to Source Breakdown Voltage		$I_D = 10 \text{mA}, V_{GS} = 0V, T_J = 150^{\circ}\text{C}$		650	-	-	v	
ΔBV <sub>DSS</sub> ΔTJ		Breakdown Voltage Temperature Coefficient		$I_D = 10$ mA, Referenced to 25°C		-	0.63	-	V/ºC	
	7		4	V <sub>DS</sub> = 480V, V <sub>GS</sub> = 0V		-	-	1		
DSS	Zero Gate Voltage Drain Current		ent	V <sub>DS</sub> =	480V, T <sub>C</sub> = 125 <sup>o</sup> C		-	-	10	μA
I <sub>GSS</sub>	Gate to	Body Leakage Currer	ıt		±20V, V <sub>DS</sub> = 0V		-	-	±100	nA
On Charac	toristic	e								
		nreshold Voltage		Vec =	V <sub>DS</sub> , I <sub>D</sub> = 250μA		3	_	5	V
R <sub>DS(on)</sub>		Prain to Source On Res	sistance		$10V, I_D = 38A$		-	36	41	mΩ
9 <sub>FS</sub>		d Transconductance		$V_{\rm DS} = 20V, I_{\rm D} = 38A$ (Note 4)			-	64.5	-	S
Dynamic (	haract	pristics		00						1
C <sub>iss</sub>	1	Capacitance				-	10800	14365	pF	
C <sub>oss</sub>		Capacitance		V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V f = 1MHz		-	324	430	pF	
C <sub>rss</sub>		e Transfer Capacitance	9			-	4.5	-	pF	
C <sub>oss</sub>		apacitance		V <sub>DS</sub> = 380V, V <sub>GS</sub> = 0V, f = 1.0MHz		-	185	-	pF	
C <sub>oss</sub> eff.		ive Output Capacitance		$V_{DS} = 0V$ to 480V, $V_{GS} = 0V$		-	748	-	pF	
Q <sub>g(tot)</sub>	Total Ga	otal Gate Charge at 10V				-	277	360	nC	
Q <sub>gs</sub>	Gate to	Source Gate Charge		V <sub>DS</sub> = 380V, I <sub>D</sub> = 38A V <sub>GS</sub> = 10V (Note 4)		-	-	65.3	-	nC
Q <sub>gd</sub>	Gate to	Drain "Miller" Charge				-	116	-	nC	
ESR	Equivalent Series Resistance			f=1MHz		-	1	-	Ω	
Switching	Charac	toristics							1	
t <sub>d(on)</sub>		n Delay Time					-	63	136	ns
-a(on) t.		n Rise Time		$V_{DD} = 380V, I_D = 38A$ $R_{GEN} = 4.7\Omega$ (Note 4)			-	66	142	ns
d(off)		f Delay Time				-	244	498	ns	
t <sub>f</sub>		f Fall Time				(Note 4)	-	53	116	ns
		de Characteristic	c			( ,				
I <sub>s</sub>		m Continuous Drain to		e Forwa	rd Current		-	-	77	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Fo						-	-	231	A
V <sub>SD</sub>		n to Source Diode Forward Voltage		$V_{GS} = 0V, I_{SD} = 38A$		-	-	1.2	V	
<u> </u>	-	e Recovery Time	5	$V_{GS} = 0V, I_{SD} = 38A$		-	190	-	ns	
		e Recovery Charge			= 100A/µs	(Note 4)	-	1490	-	nC

4. Essentially Independent of Operating Temperature Typical Characteristics

FCH041N60F 600V N-Channel MOSFET, FRFET

8

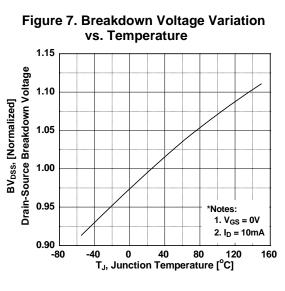
1.6



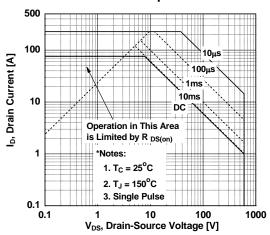
300



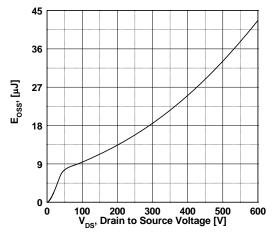
### Typical Performance Characteristics (Continued)











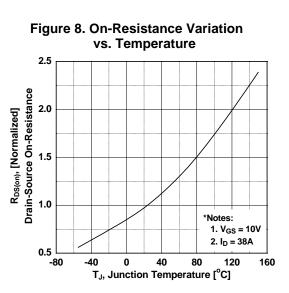
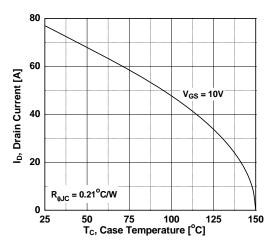
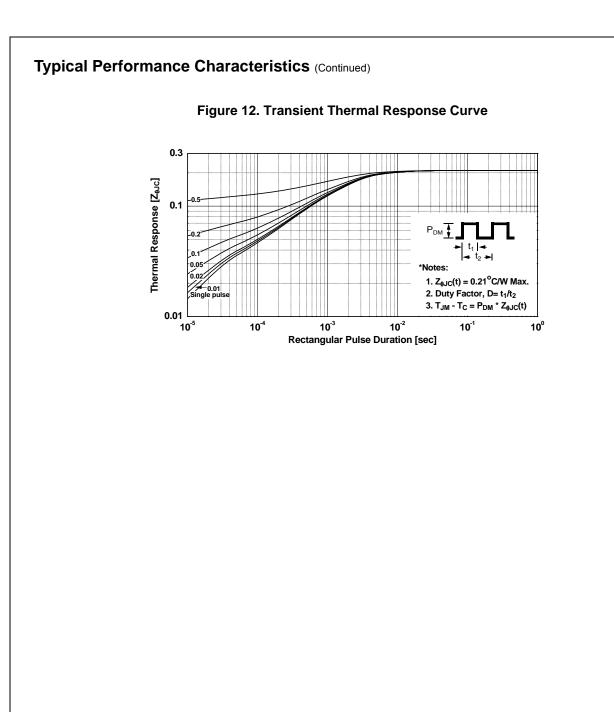
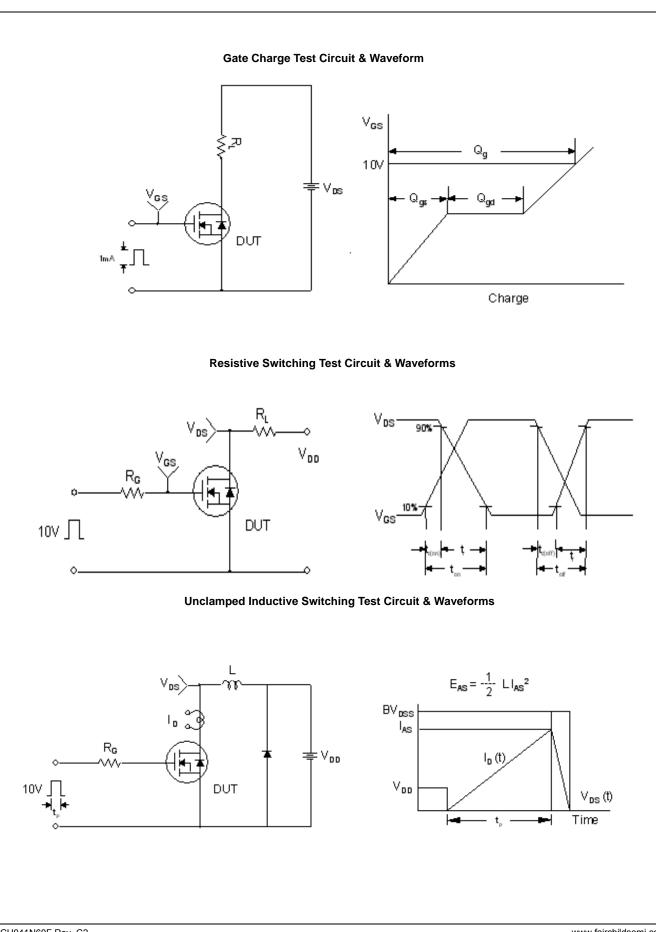


Figure 10. Maximum Drain Current

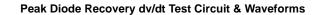


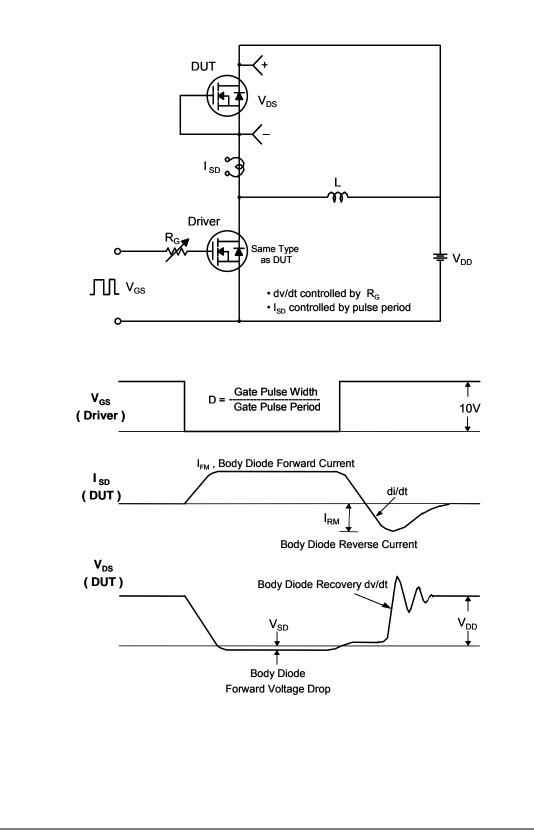


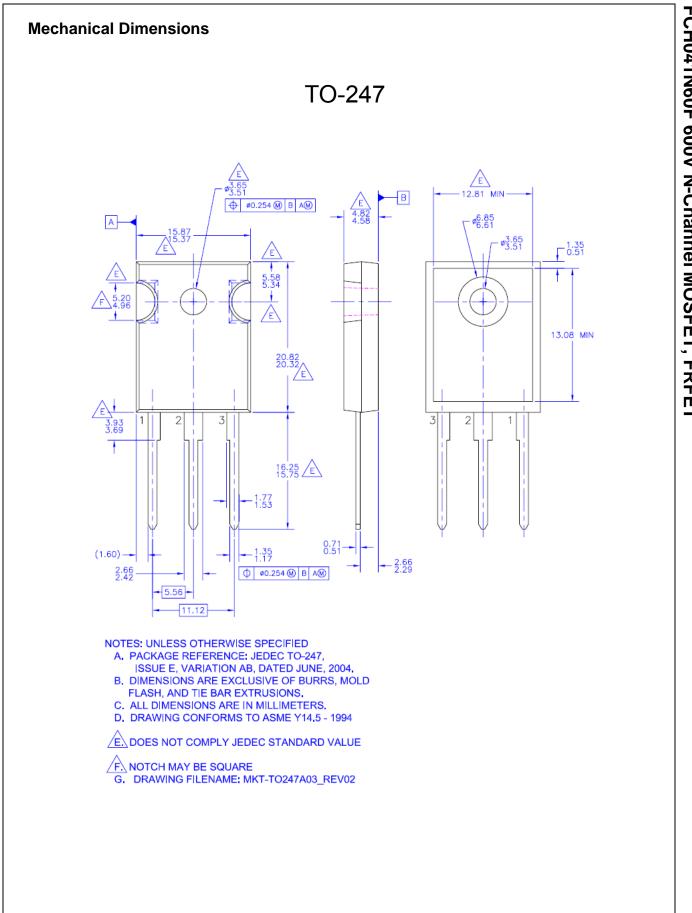




FCH041N60F 600V N-Channel MOSFET, FRFET









SEMICONDUCTOR

### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

2Cool <sup>TM</sup> AccuPower <sup>TM</sup> AX-CAP <sup>TM*</sup> BitSiC <sup>®</sup> Build it Now <sup>TM</sup> CorePLUS <sup>TM</sup> CorePOWER <sup>TM</sup> CrOSSVOLT <sup>TM</sup> CTL <sup>TM</sup> Current Transfer Logic <sup>TM</sup> DEUXPEED <sup>®</sup> Dual Cool <sup>TM</sup> EcoSPARK <sup>®</sup> EfficentMax <sup>TM</sup> ESBC <sup>TM</sup> <b>F</b> airchild <sup>®</sup> Fairchild <sup>®</sup> Fairchild <sup>®</sup> Fairchild <sup>®</sup> Fairchild <sup>®</sup> Fairchild <sup>®</sup> Fairchild <sup>®</sup> Fairchild <sup>®</sup> FAST <sup>®</sup> FAST <sup>®</sup> FastvCore <sup>TM</sup> FETBench <sup>TM</sup> FlashWriter <sup>®</sup> * FPS <sup>TM</sup>	$\begin{array}{l} F-PFS^{TM} \\ FRFET^{\otimes} \\ Global Power Resource^{SM} \\ Green FPS^{TM} \\ Green FPS^{TM} \\ Green FPS^{TM} \\ e-Series^{TM} \\ Grom \\ TM \\ Grom \\ TM \\ Grom \\ Grom$	PowerTrench <sup>®</sup> PowerXS <sup>™</sup> Programmable Active Droop <sup>™</sup> QFET <sup>®</sup> QS <sup>™</sup> Quiet Series <sup>™</sup> RapidConfigure <sup>™</sup> O <sup>™</sup> Saving our world, 1mW/W/kW at a time <sup>™</sup> SignalWise <sup>™</sup> SmartMax <sup>™</sup> SMART START <sup>™</sup> Solutions for Your Success <sup>™</sup> SPM <sup>®</sup> STEALTH <sup>™</sup> SuperSOT <sup>™</sup> -6 SuperSOT <sup>™</sup> -6 SuperSOT <sup>™</sup> -8 SuperSOT	The Power Franchise <sup>®</sup> the wer franchise TinyBoost™ TinyBoost™ TinyDogic <sup>®</sup> TINYOPTO™ TinyPower TinyPower TinyPower TinyPower TinyPower T
---	---	--	---

\*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCI AIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

#### As used here in:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's guality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### **PRODUCT STATUS DEFINITIONS** Definition of Terms

Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. 161